Schottky barriers in one-dimensional field-effect transistors: a model-based characterization

Anibal Pacheco-Sanchez, David Jiménez

Departament d'Enginyeria Electrònica, Escola d'Enginyeria, Universitat Autònoma de Barcelona, Bellaterra 08193, Spain. Email: AnibalUriel@Pacheco.uab.cat

INTRODUCTION

The characterization of the the metal-channel interfaces is of outmost importance for one-dimensional (1D) Schottky field-effect transistor (FET) technologies. The dimensionality of the channel impacts on the injection mechanisms at the Schottky contacts and hence, on the interface characteristics such as the potential barrier height [1]-[4]. The latter device parameter is proven to be underestimated in 1D channel transistors if conventional extraction techniques, e.g., the three-dimensional (3D) activation energy method (AEM), are used. Such approaches rely on the physics of 2D contacts and 3D channels which differ from the phenomena at 3D-metal-1D-channel interfaces [2]-[4]. In this work, a parameter extraction methodology for potential barrier heights in 1D FETs within the context of 1D Landauer-Büttiker transport model is reviewed. The model-based characterization method is applied to fabricated and simulated carbon nanotube (CNT) FETs and nanowire (NW) FETs with single- and multiple-channels (cf. Fig. 1). Studies on the impact of a displaced gate as well as of channel Schottky points on the extracted values are carried out with numerical device simulations.

SCHOTTKY BARRIER HEIGHT EXTRACTION

The thermionic drain current I_D of a 1D FET, corresponding to operation at the subthreshold regime, can be approximated as [1], [5]

$$I_{\rm D} \approx \Upsilon \exp\left[\frac{n_{\rm g}}{V_{\rm t}} \left(V_{\rm GS} - V_{\rm FB}\right) + \frac{n_{\rm d}}{V_{\rm t}} V_{\rm DS} - \frac{\Phi_{\rm BH, eff}}{V_{\rm t}}\right],\tag{1}$$

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$$\Phi_{\rm BH,eff} = n_{\rm q} \left(V_{\rm GS} - V_{\rm FB} \right) + \Phi_{\rm SB,eff} \tag{2}$$

where $\Phi_{\rm SB,eff} = n_{\rm d}V_{\rm DS} - (k_{\rm B}/q)\alpha$ is an effective Schottky barrier height and α is the slope of an Arrhenius plot $(\ln(I_{\rm D}T^{-1})$ vs. $T^{-1})$. $\Phi_{\rm SB,eff}$ is the parameter useful to evaluate the quality of the contacts and it is obtained from Eq. (2) at $V_{\rm DS} = 0$ and $V_{\rm GS} = V_{\rm FB}$. The latter point is obtained at the onset of tunneling phenomena corresponding to a change of slope in a $\Phi_{\rm BH,eff}$ vs. $V_{\rm GS}$ plot. The 1D Landauer-Büttiker extraction method (1D LBM) shown here is visualized in Fig. 3 where it has been applied to experimental data of a CNTFET and a NWFET with multiple 1D channels, as reported elsewhere [4].

NUMERICAL DEVICE SIMULATIONS

Simulations of BG CNTFETs have been performed with an experimentally verified in-house numerical CNT-FET simulator using a self-consistent solution of a transport equation and the Poisson equation, presented elsewhere [6], [7] in order to (*i*) explore the limits of the methodology (cf. Fig. 4), (*ii*) propose a test structure to ease the extraction (cf. Fig. 5) and (*iii*) study specific imperfections affecting the extracted values, e.g., Schottky points within the channel (cf. Fig. 6).

REFERENCES

- [1] A. Pacheco-Sanchez, *TUD Press*, Ph. D. Thesis, CEDIC-TUD, Germany, 2019
- [2] A. Pacheco-Sanchez, et al., *Appl. Phys. Lett.*, 111(16), 163108, 2017
- [3] A. Pacheco-Sanchez, et al., in Proc. IEEE LAEDC, 2020
- [4] A. Pacheco-Sanchez, et al., *J. Appl. Phys.*, 132(2), 024501, 2022
 [5] M. Claus, *TUD Press*, Ph. D. Thesis, CEDIC-TUD, Germany, 2011
- [6] M. Claus, et al., J. Comput. Elect., 13(3), 689-700, 2014
- [7] S. Mothes, *TUD Press*, Ph. D. Thesis, CEDIC-TUD, Germany, 2019

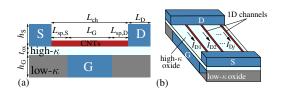


Fig. 1. Schematic (a) cross-section and (b) device structure of a buried-gate CNTFET simulated in this work [2]-[4].

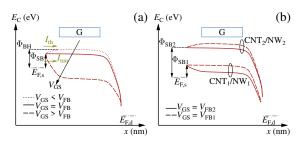


Fig. 2. Conduction band diagrams of a 1D-FET with (a) single-1Dchannel and (b) multi-1D-channels at different $V_{\rm GS}$ [4].

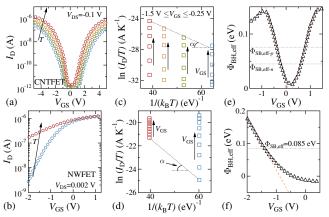


Fig. 3. Extraction of $\Phi_{\rm SB,eff}$ height of (a), (c), (e) a multitube CNTFET and (b), (d), (f) a multiwire NWFET. Further details on experimental data, plots and related discussions are provided in [4].

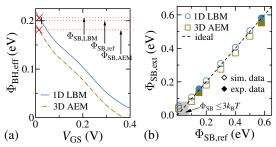


Fig. 4. Comparison between 3D AEM and 1D LBM using simulated BG CNTFETs with (a) 0.2 eV and (b) various values of Schottky barrier height. 1D LBM extracts a value close to the reference value set in simulations. Gray zone in (b) shows that both methods overestimate the value below $\sim 0.07 \text{ eV}$. Further details in [2].

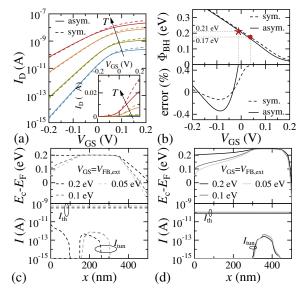


Fig. 5. Simulated symmetric and asymmetric multi-channel BG MT CNTFETs data. (a) Transfer characteristics at $V_{\rm DS}$ =0.2 V and different *T*. (b) $\Phi_{\rm SB,eff}$ extraction from the barrier height potential plot over $V_{\rm GS}$ (top) and relative error related to a linear extrapolation of pure thermionic transport (bottom). Conduction band diagrams (top) and thermionic and tunneling currents along the channel (bottom) of the (c) symmetric and (d) asymmetric CNTFETs. Details in [4].

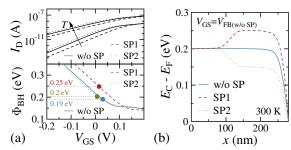


Fig. 6. Simulation results of multi-channel BG CNTFETs with and without different Schottky points. (a) Top: transfer characteristics (300 K and 500 K) at $V_{\rm DS} = 0.2$ V; bottom: potential barrier height versus $V_{\rm GS}$ obtained with 1D LBM. (b) Conduction bands at the $V_{\rm FB}$ of the device without SP. Further details in [4].